Claim Amendments

Claims 1, 4, and 18-20 have been amended. Claims 6-17 are canceled. Claims 2, 3, and 5 are unchanged. The following listing of claims replaces all previous versions of the claims in the application.

Listing of Claims

1. (currently amended) A complementary-metal-oxide-semiconductor integrated circuit having a semiconductor
substrate with a surface, the integrated circuit comprising:

a metal-oxide-semiconductor (MOS) field-effect transistor having a source, a drain, and a gate having a gate dielectric layer; and

a bipolar transistor having an emitter, a collector, and a base having a base width, wherein the base has:

a base region with a width equal to the base width that separates the emitter and collector and a length,

wherein the emitter and collector are at a distance from each other along the surface that is equal to the base width, and

a base conductor that is electrically connected to the base region along its <u>entire</u> length without being blocked by intervening portions of the gate oxide dielectric layer.

- 2. (original) The complementary-metal-oxidesemiconductor integrated circuit defined in claim 1 wherein the base conductor comprises doped semiconductor.
- 3. (original) The complementary-metal-oxide-semiconductor integrated circuit defined in claim 1 wherein the base conductor comprises doped semiconductor patterned from a crystalline semiconductor epitaxial layer grown on the base region.
- 4. (currently amended) The complementary-metal-oxide-semiconductor integrated circuit defined in claim 1

 further comprising a semiconductor substrate from which wherein the MOS transistor and bipolar transistor are formed from the semiconductor substrate and r wherein the semiconductor substrate comprises a silicon-on-insulator (SOI) substrate.
- 5. (original) The complementary-metal-oxidesemiconductor integrated circuit defined in claim 1 wherein:
 the gate comprises a gate conductor formed on top

of the gate dielectric layer from polysilicon and silicide or from metal; and

the base conductor comprises silicide.

6-17 (canceled)

18. (currently amended) A complementary-metal-oxide-semiconductor-integrated-circuit bipolar transistor on a complementary-metal-oxide-semiconductor (CMOS) integrated circuit having a semiconductor substrate with a surface, comprising:

an emitter having an emitter region in the semiconductor substrate of the CMOS integrated circuit;

a collector having a collector region in the semiconductor substrate of the CMOS integrated circuit; and

a base having:

a base region in the semiconductor substrate of the CMOS integrated circuit that lies between the emitter region and the collector region, wherein the base region has a length and a width equal to the base width and wherein the emitter region and the collector region are separated by a distance along the surface equal to the base width of the base region, and

a base conductor that lies above the base region and that is electrically connected to the base region along its entire length, wherein the base conductor serves as a path for base current in the bipolar transistor.

| 19. (currently amended) The bipolar transistor |
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| defined in claim 18 A complementary-metal-oxide-semiconductor- |
| integrated-circuit bipolar transistor on a complementary-metal- |
| oxide-semiconductor (CMOS) integrated circuit having a |
| semiconductor substrate, comprising: |
| an emitter having an emitter region in the |
| semiconductor substrate of the CMOS integrated circuit; |
| a collector having a collector region in the |
| semiconductor substrate of the CMOS integrated circuit; and |
| a base having: |
| a base region in the semiconductor substrate |
| of the CMOS integrated circuit that lies between the emitter |
| region and the collector region, wherein the base region has a |
| length and a width and wherein the emitter region and the |
| collector region are separated by the width of the base region, |
| and |
| a base conductor that lies above the base |
| region and that is electrically connected to the base region |
| along its length, wherein the base conductor serves as a path |
| for base current in the bipolar transistor, wherein the base |
| conductor comprises epitaxial crystalline semiconductor that is |
| doned more heavily than the base region |

20. (currently amended) The bipolar transistor defined in claim-18 A complementary-metal-oxide-semiconductorintegrated-circuit bipolar transistor on a complementary-metaloxide-semiconductor (CMOS) integrated circuit having a semiconductor substrate, comprising: an emitter having an emitter region in the semiconductor substrate of the CMOS integrated circuit; a collector having a collector region in the semiconductor substrate of the CMOS integrated circuit; and a base having: a base region in the semiconductor substrate of the CMOS integrated circuit that lies between the emitter region and the collector region, wherein the base region has a length and a width and wherein the emitter region and the collector region are separated by the width of the base region, and a base conductor that lies above the base region and that is electrically connected to the base region along its length, wherein the base conductor serves as a path for base current in the bipolar transistor, wherein the base conductor comprises a portion of an epitaxial silicon layer and wherein the same epitaxial silicon layer is used to form part of a source and part of a drain of a metal-oxide-semiconductor transistor.